

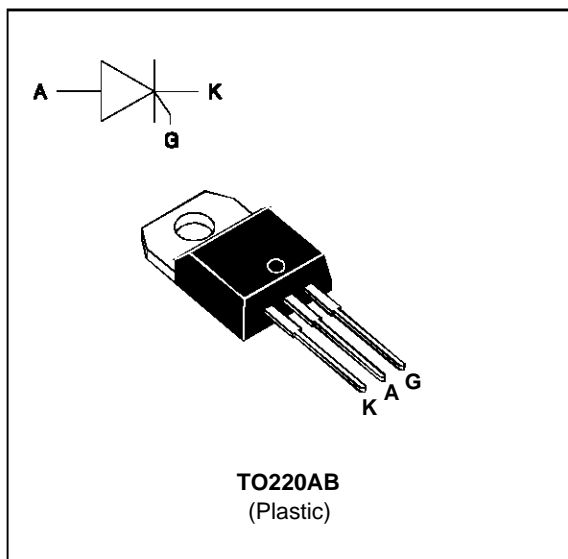
**FEATURES**

- HIGH SURGE CAPABILITY
- HIGH ON-STATE CURRENT
- HIGH STABILITY AND RELIABILITY

**DESCRIPTION**

The TYN 225 ---> TYN 1025 Family Silicon Controlled Rectifiers are high performance glass passivated chips technology.

This general purpose Family Silicon Controlled Rectifiers is designed for power supply up to 400Hz on resistive or inductive load.



**ABSOLUTE RATINGS** (limiting values)

Symbol	Parameter	Value	Unit
$I_T(RMS)$	RMS on-state current (180° conduction angle)	$T_c = 95\text{ °C}$ 25	A
$I_T(AV)$	Average on-state current (180° conduction angle, single phase circuit)	$T_c = 95\text{ °C}$ 16	A
$I_{TSM}$	Non repetitive surge peak on-state current ( $T_j$ initial = 25°C )	$t_p = 8.3\text{ ms}$ 260	A
		$t_p = 10\text{ ms}$ 250	
$I^2t$	$I^2t$ value	$t_p = 10\text{ ms}$ 310	A <sup>2</sup> s
$di/dt$	Critical rate of rise of on-state current Gate supply : $I_G = 100\text{ mA}$ $di_G/dt = 1\text{ A}/\mu\text{s}$	100	A/ $\mu\text{s}$
$T_{stg}$ $T_j$	Storage and operating junction temperature range	- 40 to + 150 - 40 to + 125	°C °C
$T_l$	Maximum lead temperature for soldering during 10 s at 4.5 mm from case	260	°C

Symbol	Parameter	TYN						Unit
		225	425	625	825	1025	1225	
$V_{DRM}$ $V_{RRM}$	Repetitive peak off-state voltage $T_j = 125\text{ °C}$	200	400	600	800	1000	1200	V

**THERMAL RESISTANCES**

Symbol	Parameter	Value	Unit
Rth (j-a)	Junction to ambient	60	°C/W
Rth (j-c) DC	Junction to case for DC	1.3	°C/W

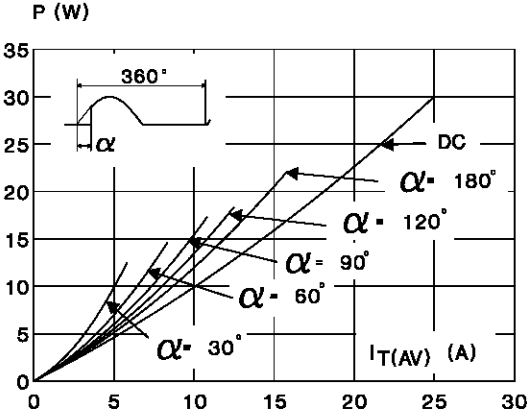
**GATE CHARACTERISTICS (maximum values)**

$P_G (AV) = 1W$   $P_{GM} = 10W$  ( $t_p = 20 \mu s$ )  $I_{FGM} = 4A$  ( $t_p = 20 \mu s$ )  $V_{RGM} = 5V$ .

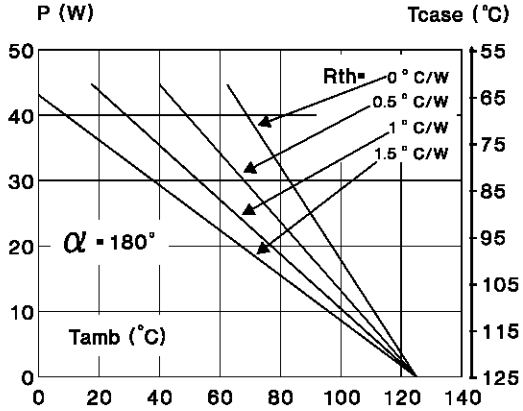
**ELECTRICAL CHARACTERISTICS**

Symbol	Test Conditions			Value	Unit
$I_{GT}$	$V_D=12V$ (DC) $R_L=33\Omega$	$T_j=25^\circ C$	MAX	40	mA
$V_{GT}$	$V_D=12V$ (DC) $R_L=33\Omega$	$T_j=25^\circ C$	MAX	1.5	V
$V_{GD}$	$V_D=V_{DRM}$ $R_L=3.3k\Omega$	$T_j=125^\circ C$	MIN	0.2	V
tgt	$V_D=V_{DRM}$ $I_G = 200mA$ $di_G/dt = 1.5A/\mu s$	$T_j=25^\circ C$	TYP	2	$\mu s$
$I_L$	$I_G = 1.2 I_{GT}$	$T_j=25^\circ C$	TYP	80	mA
$I_H$	$I_T = 100mA$ gate open	$T_j=25^\circ C$	MAX	50	mA
$V_{TM}$	$I_{TM} = 50A$ $t_p = 380\mu s$	$T_j=25^\circ C$	MAX	1.6	V
$I_{DRM}$ $I_{RRM}$	$V_{DRM}$ Rated $V_{RRM}$ Rated	$T_j=25^\circ C$	MAX	0.01	mA
		$T_j=125^\circ C$		4	
dV/dt	Linear slope up to $V_D=67\%V_{DRM}$ gate open	$T_j=125^\circ C$	MIN	500	V/ $\mu s$
tq	$V_D=67\%V_{DRM}$ $I_{TM} = 50A$ $V_R = 25V$ $di_{TM}/dt=30 A/\mu s$ $dV_D/dt=50V/\mu s$	$T_j=125^\circ C$	TYP	70	$\mu s$

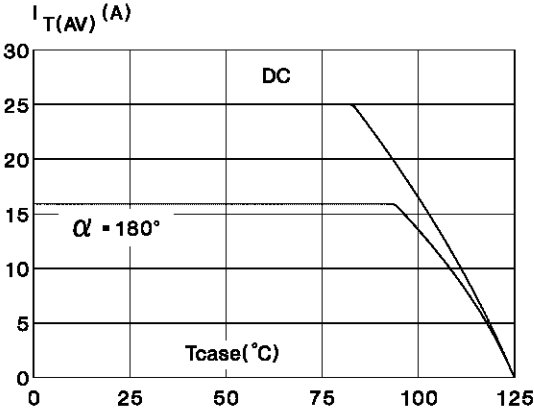
**Fig.1** : Maximum average power dissipation versus average on-state current.



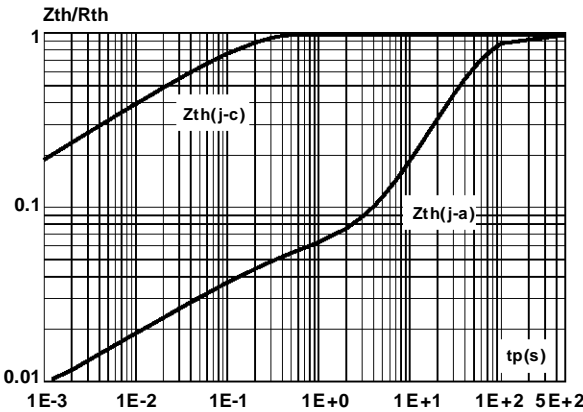
**Fig.2** : Correlation between maximum average power dissipation and maximum allowable temperatures ( $T_{amb}$  and  $T_{case}$ ) for different thermal resistances heatsink + contact.



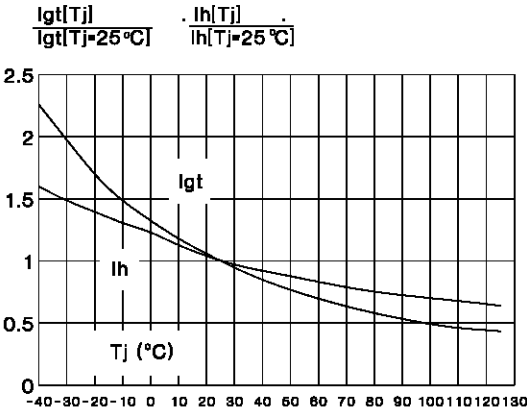
**Fig.3** : Average on-state current versus case temperature.



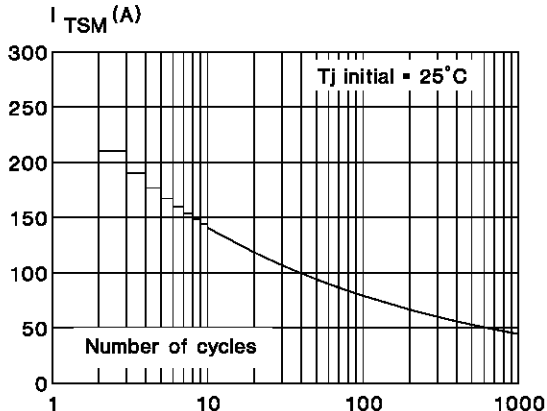
**Fig.4** : Relative variation of thermal impedance versus pulse duration.



**Fig.5** : Relative variation of gate trigger current versus junction temperature.

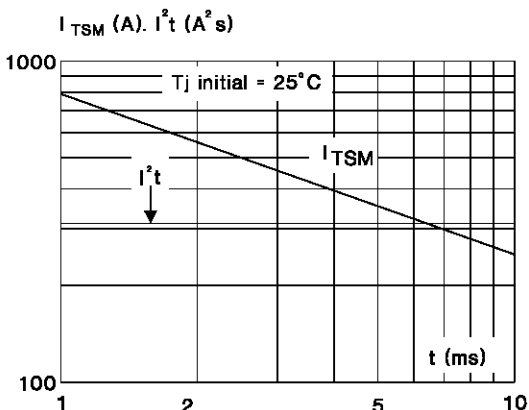


**Fig.6** : Non repetitive surge peak on-state current versus number of cycles.

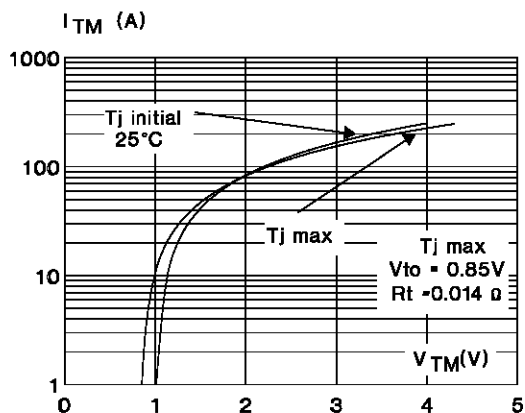


## TYN 225 ---> TYN 1225

**Fig.7** : Non repetitive surge peak on-state current for a sinusoidal pulse with width :  $t \leq 10$  ms, and corresponding value of  $I^2t$ .

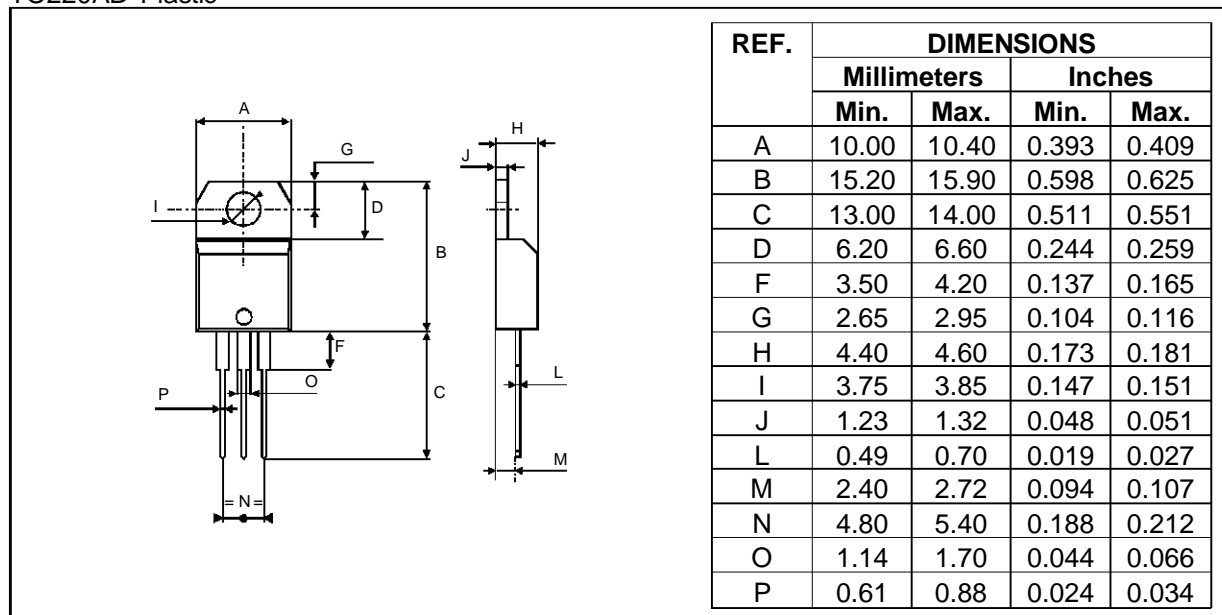


**Fig.8** : On-state characteristics (maximum values).



### PACKAGE MECHANICAL DATA

TO220AB Plastic



Cooling method : C  
Marking : type number  
Weight : 2.3 g

Recommended torque value : 0.8 m.N.  
Maximum torque value : 1 m.N.

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